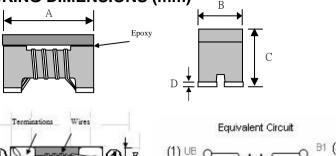
SPECIFICATION RoHS Version: 1.0 COMPLIANT ITEM P/N BT2012N-750 **TEST INSTRUMENT Network Analyzer PRODUCT** 1000~1500 **Chip Balun Transformer** Freq. Range(MHz)

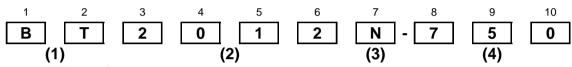




(2)

BT2012 N	Dimensions
А	2.0 ± 0.2
В	1.2 ± 0.2
С	1.2 ± 0.2
D	0.2 ± 0.1
Е	0.40 Typ
F	0.45 Typ

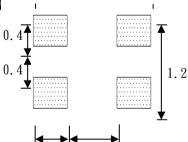
EXPLANATION OF PART NUMBERS



- (1) Product name Chip Balun Transformer
- (2) Dimensions (L X W) (mm) 2.0 X 1.2
- (3) Shielding Type for 1.5 GHz
- (4) Impedance $750:75\Omega$

Recommended Soldering Conditions (Please use this product by reflow soldering)

Recommended Footprint(mm)



ELECTRICAL CHARACTERISTICS

		01100							
	Freq.	UB/B	Insertion	CMDD	Rated	DCD	Withstand	Insulation	Rated
P/N	Range	Impedance	Loss	CMRR (dB)	Voltage	DCR (Ω)	Voltage	Resistance	POWE R
	(MHz)	(ohm)	(dB)	(ab)	(DC)	(32)	(DC)	Min. (MΩ)	(dBm)
BT2012N-750	1000~1500	75/75	1.4 max	20 min	20V	0.59	50V	10	27

- Operating and storage temperature range (individual chip without packing): $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$.
- Storage temperature range (packaging conditions): -10 $^{\circ}\text{C} \sim +40\,^{\circ}\text{C}$ and RH 70% (Max.)

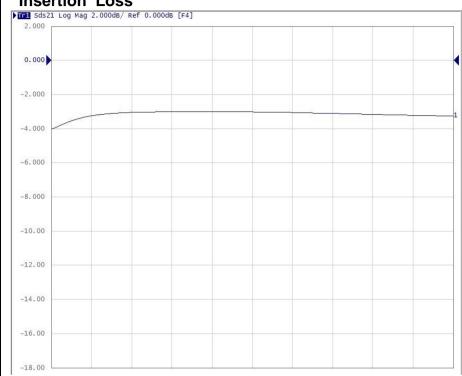
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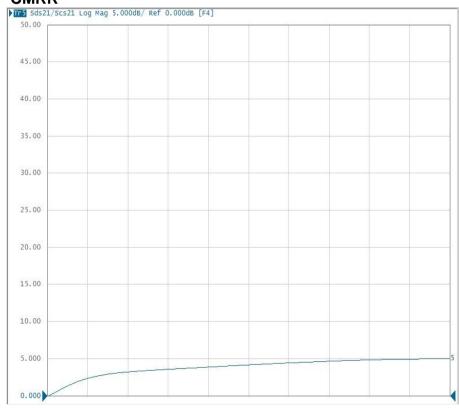
HUNGTRON TECHNOLOGY Co.,Ltd.

Version: 1.0	CHARACTER	RoHS COMPLIANT	
ITEM P/N	BT2012N-750	TEST INSTRUMENT	Network Analyzer
PRODUCT	Chip Balun Transformer	Freq. Range(MHz)	1000~1500

Insertion Loss



CMRR



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Version: 1.0 CHARACTERISTICS ROHS COMPLIANT ITEM P/N BT2012N-750 TEST INSTRUMENT Network Analyzer PRODUCT Chip Balun Transformer Freq. Range(MHz) 1000~1500

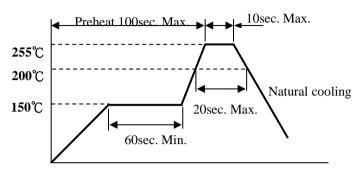
Electrical Test

TEST	Requirement	Method Used
Insertion Loss	Refer to Page1 ELECTRICAL CHARACTERISTICS	Insertion Loss is measured with Network Analyzer Port1 Port2 Port2
CMRR	Refer to Page2 ELECTRICAL CHARACTERISTICS	Common Mode Rejection Ratio (CMRR) is a function of both amplitude imbalance and phase imbalance. If a differential VNA is not available, CMRR can be computed based on single ended measurement. CMRR[dB] = 20log10(Sds21/Scs21) = 20log10{(S21+S31)/(S21-S31)} Where, Sds21 is S-parameter of single mode stimulus - Differential mode response Scs21 is S-parameter of single mode stimulus - Common mode response It is assumed that the single-ended S-parameters are obtained with proper matched-load termination at each port.
Withstand Voltage	Refer to Page3 ELECTRICAL CHARACTERISTICS	Apply DC Voltage between Terminal 1 and Terminal 2 for 5 seconds. The DC Voltage is 2.5 times of the rated voltage. No damage shall be observed after the testing. Terminal 1 Terminal 2 Terminal 2
Insulation Resistance	Refer to Page4 ELECTRICAL CHARACTERISTICS	Test equipment: High resistance meter HP4339. Apply rated voltage, then measure resistance between Terminal 1 and Terminal2. Terminal 1 Terminal 2 Terminal 2



Version: 1.0	RELIABIL	RoHS COMPLIANT	
ITEM P/N	BT2012N-750	TEST INSTRUMENT	Network Analyzer
PRODUCT	Chip Balun Transformer	Freq. Range(MHz)	1000~1500

RECOMMENDED SOLDERING TEMP. GRAPH



MECHANICAL RELIABILITY

TEST	Specification & R	equirement	Method Used	
	The surface of terminal/pin tested shall		Solder heat proof:	
Solderability	be covered with new solder by 90%		Preheating: 150 ±10℃ 60 seconds	
			Soldering: 245 ±5℃ for 4 ±1 sec	
	Components should have not evidence of		Preheating:150°C 60secs	
Solder Heat	Solder Heat electrical and mechannical damage Resistance Impedance:within ±15% of initial value		Solder temperature: 260±5°C	
Resistance			Flux:rosin	
			Dip time:10±0.5 secs	
	Series No.	F (Kg)	Solder a chip to test substrate and then	
	BT2012A-750	0.5	laterally apply a force in the arrow direction	
Terminal strength			Test Board	

ENDURANCE RELIABILITY

TEST	Specification & Requirement	Method Used	
	Impedance change within ± 15% Without	-65°C, (30 mins) -> room temp. (2 mins) ->	
Thermal Shock	mechanical damage	125 ℃, (30 mins) -> room temp. (2 mins)	
		50 cycles	
Humidity	Impedance change within ± 15% Without	Apply IDC current @ 60°C ambient	
Resistance	mechanical damage	Humidity: 90%	
Resistance		Duration: 168 hrs	
Low Temp.	Impedance change within ± 15% Without	Storing Temp.	
Storing	mechanical damage	-40 ±2 °C for total 168 +5/-0 hours	
Ligh Town	Impedance change within ± 15% Without	Storing Temp.	
High Temp. Storing	mechanical damage	125 ±2 °C for total 168 +5/-0 hours	

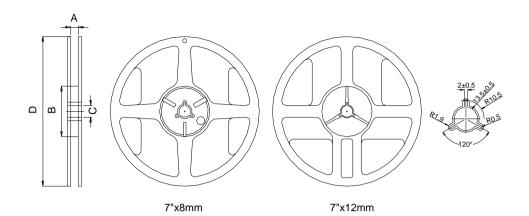
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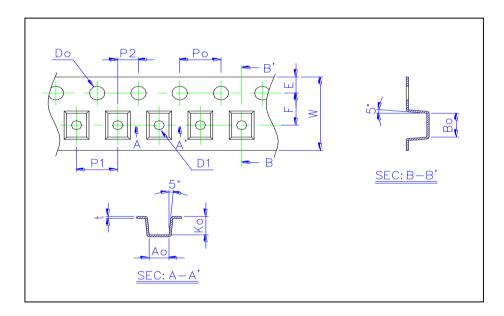
HUNGTRON TECHNOLOGY Co.,Ltd.

Version: 1.0	PACKING FO	RoHS COMPLIANT	
ITEM P/N	BT2012N-750	TEST INSTRUMENT	Network Analyzer
PRODUCT	Chip Balun Transformer	Freq. Range(MHz)	1000~1500

Reel Dimension & Tape Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60±2	13.5±0.5	178±2



Size	Ao(mm)	Bo(mm)	Ko(mm)	W(mm)	E(mm)	F(mm)	Po(mm)	P1(mm)	Do(mm)
2012	2.35±0.10	1.50±0.10	1.45±0.10	8.00±0.20	1.75±0.10	3.50±0.05	4.0±0.05	4.0±0.10	1.0±0.1

Packaging Quantity

Chip Size	2012
8mm/ Reel	2000



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